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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE BY SECURED PARTY

CONVEYING PARTY DATA

Name	Execution Date
PNC Bank, National Association, as Administrative Agent	08/01/2007

RECEIVING PARTY DATA

Name:	E K Success Ltd.	
Street Address:	261 River Road	
City:	Clifton	
State/Country:	NEW JERSEY	
Postal Code:	07014	

PROPERTY NUMBERS Total: 14

Property Type	Number
Patent Number:	6854184
Patent Number:	6826838
Patent Number:	6644483
Patent Number:	D481608
Patent Number:	6560891
Patent Number:	D470026
Patent Number:	6453573
Patent Number:	6418635
Patent Number:	6361076
Patent Number:	D435064
Patent Number:	6112425
Patent Number:	D420386
Application Number:	29230752
Application Number:	11030582

CORRESPONDENCE DATA

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Correspondent Name: Magdalini Rizakos c/o Latham & Watkins

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NAME OF SUBMITTER:

Magdalini Rizakos

Total Attachments: 5

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RELEASE OF SECURITY INTEREST IN PATENTS (FIRST LIEN)

THIS RELEASE OF SECURITY INTEREST IN PATENTS (FIRST LIEN) (this "Release") is made as of August 1, 2007 ("Effective Date") by and between PNC Bank, National Association, with its principal office at Firstside Center, 4th Floor, 500 First Avenue, Pittsburgh, PA 15219, as administrative agent (together with its successor(s) thereto in such capacity, for each of the Secured Parties (as defined in the Security Agreement), "Grantee"), and E K Success Ltd., a New York corporation, with its principal office at 261 River Road, Clifton

WHEREAS, pursuant to the terms and conditions of that certain Patent Security Agreement (First Lien) by and between Company and Grantee dated February 17, 2006 (the "Patent Security Agreement"), Company granted to Grantee a continuing security interest in and to the Patent Collateral (as defined in the Patent Security Agreement), including, without limitation, the United States patents and patent applications set forth on Schedule A attached hereto;

WHEREAS, Company and Grantee entered into the Patent Security Agreement pursuant to the terms and conditions of that certain Pledge and Security Agreement (First Lien) executed and delivered by Company and dated February 17, 2006 (as amended, supplemented, amended and restated or otherwise modified from time to time, the "Security Agreement");

WHEREAS, Company executed and delivered the Security Agreement in connection with that certain Credit and Guaranty Agreement (First Lien), dated as of February 17, 2006 (as amended, supplemented, amended and restated or otherwise modified from time to time, the "Credit Agreement"), among the Borrower (as defined therein), Holdings (as defined therein), the various financial institutions and other Persons (as defined therein) from time to time parties thereto (each a "Lender"), and the Grantee.

WHEREAS the Patent Security Agreement was recorded with the United States Patent and Trademark Office ("PTO") on February 22, 2006, at Reel 017198, Frame 0142;

WHEREAS, Company has paid all of its outstanding indebtedness to Grantee.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Grantee hereby terminates the Patent Security Agreement, the Security Agreement, and the Credit Agreement and hereby terminates, cancels and releases any and all security interests it has against the Patent Collateral (as defined in the Patent Security Agreement).

Grantee represents and warrants that: (i) it has the full power and authority to execute this Release; (ii) it has not assigned, transferred, restricted or otherwise encumbered any security interest it has against the Patent Collateral; and (iii) it has not recorded or otherwise evidenced its security interest with respect to any Patent Collateral, other than the Patent Collateral set forth on Schedule A (attached hereto), in any jurisdiction throughout the world.

Grantee shall, at Company's expense, take all further actions, and provide to Company, Company's successors, assigns or other legal representatives, all such cooperation and

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NJ 07014 ("Company").

assistance (including, without limitation, the execution and delivery of any and all documents or other instruments), requested by Company to more fully and effectively effectuate the purposes of this Release.

* * * * *

IN WITNESS WHEREOF, Grantee has caused this Release to be executed by its duly authorized representative as of the Effective Date.

PNC BANK, NATIONAL ASSOCIATION, as Administrative Agent

Name: Mehre / T. Layuac

Title: SVP

SCHEDULE A

Issued Patents

<u>Country</u>	<u>Title</u>	Patent No.	<u>Issue Date</u>
USA	Blade cover for cutting device	6,854,184	2/15/05
USA	Clip-on comer alignment device	6,826,838	12/7/04
USA	Hanger display assembly	6,644,483	11/11/03
USA	Cutting device	D481.608	11/4/03
USA	Punch tool alignment device	6,560,891	5/13/03
USA	Scissor	D470,026	2/11/03
USA	Rubber stamp positioning device	6,453,573	9/24/02
USA	Page maker template	6,418,635	7/16/02
USA	Spinning disk assembly	6,361,076	3/26/02
USA	Cutting mat	D435,064	12/12/00
USA	Border, corner and cut-out template	6,112,425	9/5/00
USA	Banded marker	D420,386	2/8/00

Pending Patent Applications

Country	Application No.	Filing Date	Owner
USA	29/230,752	5/25/05	Inventors Kim M. Nork and Rebecca Nocella
USA	11/030.582	1/5/05	Inventors Chung
			Heng Lee and
			Rebecca Nocella ²

Patent Applications in Preparation

None.

RECORDED: 08/08/2007

This patent application has been assigned to EK Success Ltd.

Ms. Rebecca Nocella's interest in this patent application has been assigned to EK Success Ltd. EK Success Ltd. has obtained rights to use Mr. Chung Heng Lee's interest in this patent application pursuant to an Amendment, dated February 9, 2006, by and between EK Success. Ltd., Waltjun Industrial. Inc., Cheng Ho Lee and Chung Heng Lee, to the License Agreement, dated April 11, 2000, by and between Waltum Industrial, Inc. and EK Success Ltd.